

## Thick Film Chip Resistor Array

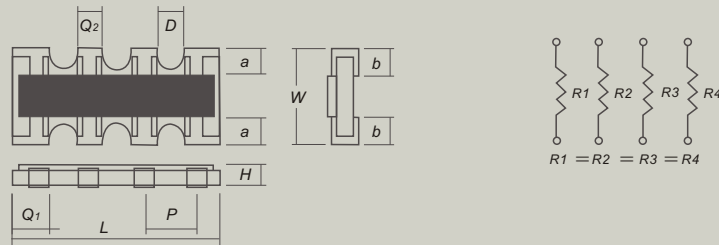
**RA03 (0603SIZE / 4-ELEMENTS)**

**RA02 (0402SIZE / 4-ELEMENTS)**

### FEATURES

1. High density SMD packaging gives higher productivity and reduced assembly costs.
2. Suitable for flow and reflow soldering.
3. Suitable for automatic surface mount.

### DIMENSIONS AND STRUCTURE



Unit: mm

STYLE	TYPE	Terminal	L	W	H	Q <sub>1</sub>	a	b	p	Q <sub>2</sub>	D
RA 02	024R	Convex	2.0±0.1	1.0±0.1	0.45±0.1	0.3±0.1	0.2±0.1	0.3±0.1	0.5±0.1	0.2±0.1	0.2±0.1
RA 03	034R	Convex	3.2±0.15	1.6±0.2	0.6±0.1	0.65±0.15	0.3±0.15	0.3±0.15	0.8±0.1	0.45±0.1	0.38±0.1

### RATINGS

TYPE	Rated Power At 70°C (w)	Maximum Working Voltage (V <sub>w</sub> )	Maximum Overload Voltage (V <sub>o</sub> )	Temperature Coefficient of Resistance (ppm/°C)	Resistance Range	Resistance Tolerance	Operating Temperature Range (°C)
024R	1/16	50	100	±200	10Ω~1MΩ	J(±5%) F(±1%)	-55~+125
034R	1/16	50	100	±200	10Ω~1MΩ	J(±5%) F(±1%)	